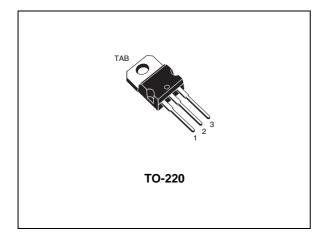


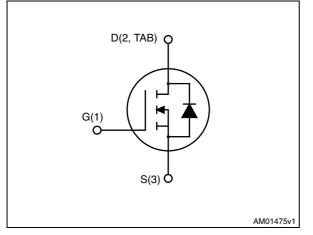
# STP80N6F6

Datasheet - production data

### Automotive-grade N-channel 60 V, 4.4 mΩ typ., 80 A STripFET™ VI DeepGATE™ Power MOSFET in a TO-220 package



### Figure 1. Internal schematic diagram



### Features

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ID
STP80N6F6	60 V	$5 \text{ m}\Omega$	80 A <sup>(1)</sup>

1. Current limited by package

- Designed for automotive applications and AEC-Q101 qualified
- Low gate charge
- Very low on-resistance
- High avalanche ruggedness

### **Applications**

• Switching applications

### Description

This device is an N-channel Power MOSFET developed using the 6<sup>th</sup> generation of STripFET<sup>™</sup> DeepGATE<sup>™</sup> technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest R<sub>DS(on)</sub> in all packages.

#### Table 1. Device summary

Order code	Marking	Packages	Packaging
STP80N6F6	80N6F6	TO-220	Tube

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# 1 Electrical ratings

Symbol	Parameter	Value	Unit	
V <sub>DS</sub>	Drain-source voltage	60	V	
V <sub>GS</sub>	Gate-source voltage	± 20	V	
Ι <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	80	А	
$I_{D}^{(1)}$	Drain current (continuous) at T <sub>C</sub> = 100 °C	80	А	
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	320	А	
P <sub>TOT</sub>	Total dissipation at $T_{C} = 25 \text{ °C}$	120	W	
	Derating factor	0.8	W/°C	
T <sub>stg</sub>	Storage temperature	55 to 175	°C	
Тj	- 55 to 175			

Table 2. Absolu	ite maximum	ratings
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1. Current limited by package

#### Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	1.25	°C/W
R <sub>thj-a</sub>	Thermal resistance junction-ambient max	62.5	°C/W



## 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Table 4. On/on states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage (V <sub>GS</sub> = 0)	I <sub>D</sub> = 250 μA	60			V
1	Zero gate voltage	V <sub>DS</sub> = 60 V			1	μA
IDSS	Drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 60 V, T <sub>C</sub> =125 °C			100	μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3		4.5	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 40 \text{ A}$		4.4	5	mΩ

Table 4. On/off states

#### Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	8325	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 25 V, f = 1 MHz,	-	500	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	V <sub>GS</sub> = 0	-	400	-	pF
Qg	Total gate charge		-	147	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 80 A, V <sub>GS</sub> = 10 V	-	44	-	nC
Q <sub>gd</sub>	Gate-drain charge		-	46	-	nC

#### Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	40	-	ns
t <sub>r</sub>	Rise time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 40 A		71		ns
t <sub>d(off)</sub>	Turn-off-delay time	R <sub>G</sub> = 4.7 Ω V <sub>GS</sub> = 10 V	-	132	-	ns
t <sub>f</sub>	Fall time		-	40	-	ns



Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current		-		80	А
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		320	А
$V_{SD}^{(2)}$	Forward on voltage $I_{SD} = 80 \text{ A}, V_{GS} = 0$		-		1.3	V
t <sub>rr</sub>	Reverse recovery time $I_{SD} = 80 \text{ A}, V_{DD} = 48 \text{ V}$		-	46		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/ $\mu$ s,	-	65		nC
I <sub>RRM</sub>	Reverse recovery current	T <sub>j</sub> = 150 °C	-	2.8		А

Table 7. Source drain diode

1. Current limited by package.

2. Pulsed: pulse duration =  $300 \,\mu$ s, duty cycle 1.5%



### 2.1 Electrical characteristics (curves)

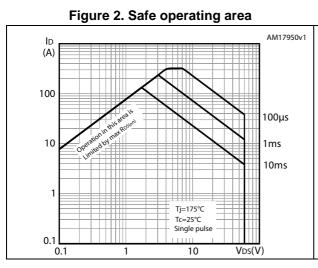
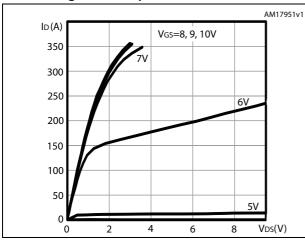
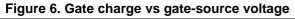


Figure 4. Output characteristics





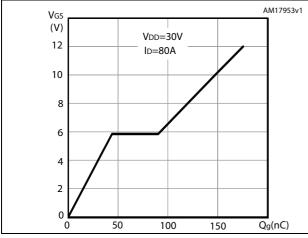


Figure 5. Transfer characteristics

10-2

10-3

0.05 0.02

0.01

SINGLE PULSE

10<sup>-4</sup>

 $Z_{th} = k R_{thJ-c}$ 

10<sup>-1</sup> tp (s)

 $\delta = t_p / \tau$ 

Figure 3. Thermal impedance

к

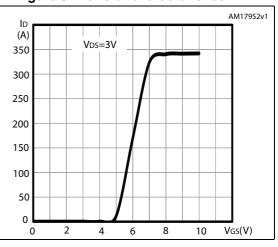
10 -1

10<sup>-2</sup> 10<sup>-5</sup>

δ = 0.5

0.2

0.1



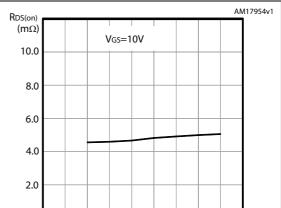


Figure 7. Static drain-source on-resistance

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0.0

0

10 20 30 40 50 60 70



ID(A)

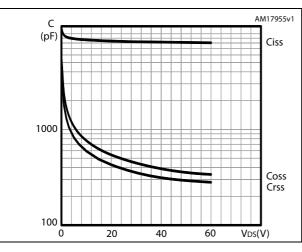
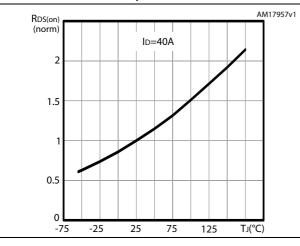
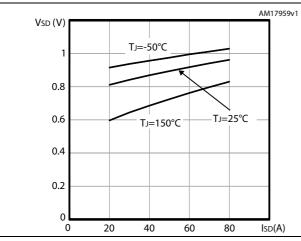


Figure 8. Capacitance variations

# Figure 10. Normalized on-resistance vs temperature

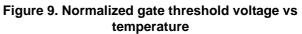


# Figure 12. Source-drain diode forward characteristics





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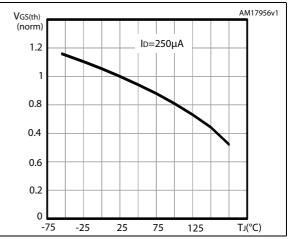
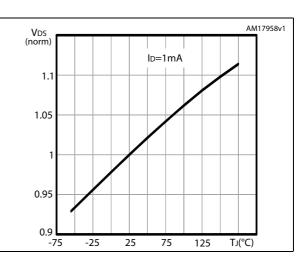


Figure 11. Normalized  $V_{\text{DS}}$  vs temperature

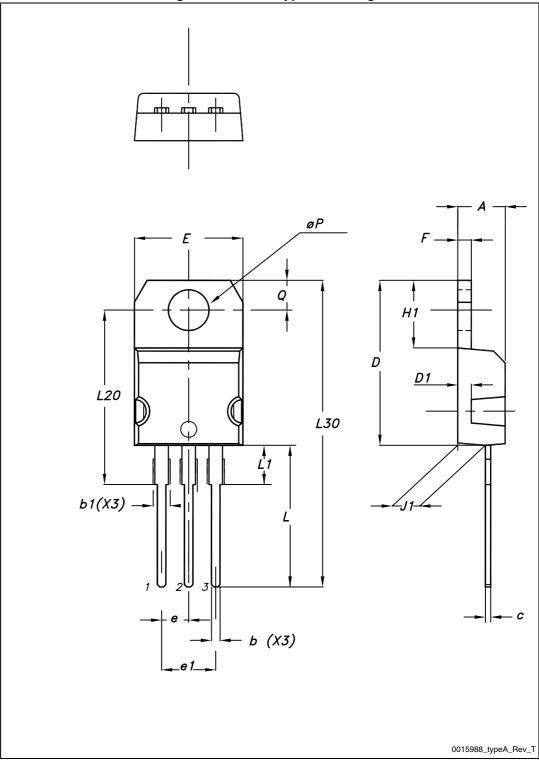


## 3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



Figure 13. TO-220 type A drawing





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Dim.		mm		
Dini.	Min.	Тур.	Max.	
А	4.40		4.60	
b	0.61		0.88	
b1	1.14		1.70	
с	0.48		0.70	
D	15.25		15.75	
D1		1.27		
E	10		10.40	
е	2.40		2.70	
e1	4.95		5.15	
F	1.23		1.32	
H1	6.20		6.60	
J1	2.40		2.72	
L	13		14	
L1	3.50		3.93	
L20		16.40		
L30		28.90		
ØР	3.75		3.85	
Q	2.65		2.95	

Table 8. TO-220 type A mechanical data



## 4 Revision history

Date	Revision	Changes
08-Aug-2012	1	Initial release.
21-Jan-2014	2	<ul> <li>Document status promoted from preliminary to production data</li> <li>Modified: title</li> <li>Modified: <i>Features</i></li> <li>Added: note 1 in cover page</li> <li>Modified: R<sub>DS(on)max</sub> and I<sub>D</sub> values in cover page</li> <li>Modified: I<sub>D</sub> (at TC = 25 °C and at TC = 100 °C) values, I<sub>D</sub>, I<sub>DM</sub> values and added note 1 in <i>Table 2</i></li> <li>Modified: R<sub>thj-case</sub> value in <i>Table 3</i></li> <li>Modified: R<sub>DS(on)</sub> values in <i>Table 4</i></li> <li>Modified: I<sub>D</sub> and the entire typical values in <i>Table 5</i>, 6 and 7</li> <li>Added: Section 2.1: Electrical characteristics (curves)</li> <li>Updated: Section 3: Package mechanical data</li> <li>Minor text changes</li> </ul>

Table 9. Document revision history



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